

AN-2244 LP5907 DSBGA Evaluation Board Information

1 Introduction

This evaluation board is designed to enable the evaluation of the LP5907 Voltage Regulator. Each board is assembled and tested in the factory. This evaluation board has the 4-bump DSBGA package mounted.

2 General Description

The LP5907 is a linear regulator capable of supplying 250 mA output current. Designed to meet the requirements of RF/Analog circuits, the LP5907 provides low device noise, high PSRR, low quiescent current, and low line transient response. Using new innovative design techniques, the LP5907 offers class-leading noise performance without a noise bypass capacitor.

The device has been designed to work with 1.0 μF input and output ceramic capacitors down to 0603 component size.

3 Operation

The input voltage, applied between V_{IN} and GND, should be at least 1.0V greater than V_{OUT} and no more than 5.5V. The minimum operating voltage is 2.2V. Loads can be connected to V_{OUT} with reference to GND. V_{OUT} and V_{IN} sense pins are provided on the board to allow accurate measurements directly onto the input and output pins of the device, eliminating any voltage drop on the PCB traces or connecting wires to the load.

ON/OFF control is provided by a two-way jumper on the V_{EN} pin. A minimum of 1.2V is required at this pin to enable the LDO. The LDO will be shut down when the V_{EN} pin is set to 0.4V or less.

In applications where the LP5907 is operated continuously from the battery, V_{IN} and V_{EN} can be tied together. However, if ON/OFF control is required, the V_{EN} pin should be driven from a separate signal to ensure correct operation of the fast startup circuit. The device has a $1M\Omega$ internal resistor from V_{EN} to GND.



Hardware www.ti.com

4 Hardware

The schematic and layout of the evaluation board are given below:

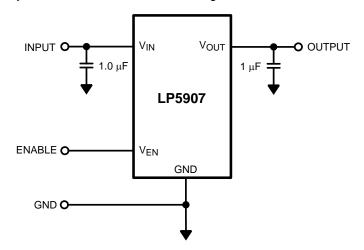


Figure 1. Evaluation Board Schematic

5 PCB Layout

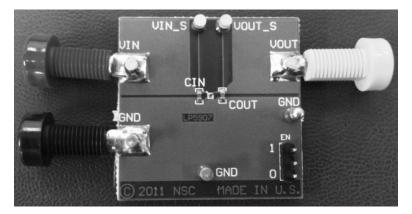


Figure 2. LP5907 Evaluation Board with Components (Top)



Figure 3. LP5907 Evaluation Board (Bottom)



www.ti.com Hardware

6 Hardware

Designator	Value	Amount	Footprint	Note
DUT	LP5907	1	YKE0004AAA	
CIN	1.0 μF	1	0603	X7R, X5R
COUT	1.0 μF	1	0603	X7R, X5R
VIN, VOUT, GND, EN, VIN_S, VOUT_S pins	I/O and Test Pins	8		

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive Communications and Telecom **Amplifiers** amplifier.ti.com www.ti.com/communications **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps

DSP **Energy and Lighting** dsp.ti.com www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical logic.ti.com Logic Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID <u>www.ti-rfid.com</u>

OMAP Applications Processors www.ti.com/omap TI E2E Community e2e.ti.com

Wireless Connectivity <u>www.ti.com/wirelessconnectivity</u>